

STPS3L40-Y

Automotive power Schottky rectifier

Features

- Negligible switching losses
- Low thermal resistance
- Low forward voltage drop
- Avalanche capability specified
- ECOPACK[®]2 compliant component
- AEC-Q101 qualified

Description

Schottky rectifier suited for switched mode power supplies and high frequency DC to DC converters. Packaged in SMC, this device is intended for use in DC/DC chargers for automotive application.



Table 1.Device summary

Symbol	Value
I _{F(AV)}	3 A
V _{RRM}	40 V
T _j (max)	150 °C
V _F (max)	0.44 V

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1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	40	V	
I _{F(AV)}	Average forward current	$T_L = 120 \ ^\circ C \ \delta = 0.5$	3	А
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	75	А
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \ \mu s \ Tj = 25 \ ^{\circ}C$		1300	W
T _{stg}	Storage temperature range	-65 to + 175	°C	
Тj	Operating junction temperature range(-40 to +150	°C	
dDtot	4			

 $1. \quad \frac{dPtot}{dTj} < \frac{1}{Rth(j-a)} \text{ condition to avoid thermal runaway for a diode on its own heatsink}$

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-l)}	Junction to lead	18	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
ا _B ⁽¹⁾	Reverse leakage current	$T_j = 25 \ ^{\circ}C$	V _R = V _{RRM}		100	μA
'R` ′		T _j = 125 °C		16	40	mA
		T _j = 25 °C	– I _F = 3 A		0.5	
V _F ⁽¹⁾	Forward voltage drop	T _j = 125 °C		0.40	0.44	v
VF` ′	Forward voltage drop	T _j = 25 °C	I _F = 6 A		0.62	v
		T _j = 125 °C		0.52	0.58	

1. Pulse test: tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation:

 $P = 0.30 \text{ x } I_{F(AV)} + 0.047 I_{F}^{2}(RMS)$



Figure 3.

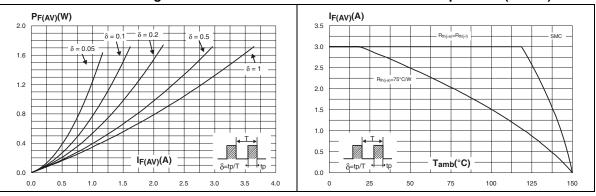


Figure 1. Average forward power dissipation Figure 2. Av versus average forward current an

Non repetitive surge peak forward

current versus overload duration

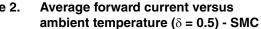
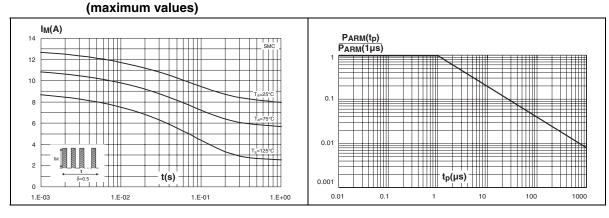


Figure 4. Normalized avalanche power derating versus pulse duration



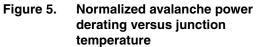
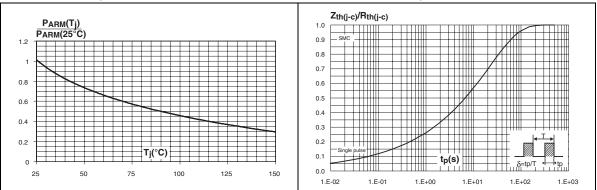


Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration



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Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

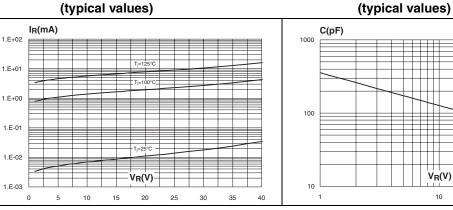


Figure 9. Forward voltage drop versus forward current

Figure 10. Thermal resistance junction to ambient versus copper surface under each lead

Junction capacitance versus

reverse voltage applied

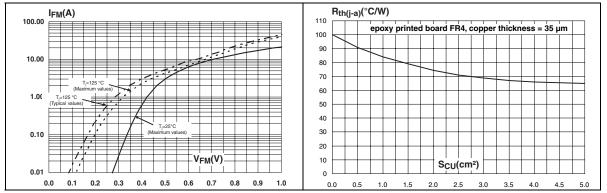


Figure 8.



2 Package information

- Epoxy meets UL94,V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 5. SMC package dimensions

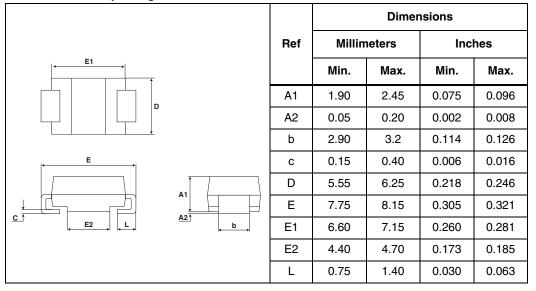
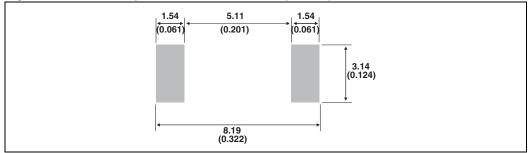


Figure 11. SMC footprint dimensions in mm (inches)



3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS3L40SY	S3L4Y	SMC	0.24 g	2500	Tape and reel

4 Revision history

Table 7.Document revision history

Date	Revision	Changes	
10-Mar-2011	1	First issue.	



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